

# RTC-700C

## Environment Test Report

Report NO: 14R020001

Summary	<p><input checked="" type="checkbox"/> <b>Pass</b></p> <p><input type="checkbox"/> <b>Fail</b></p> <p>Note : There is/are ____ defect(s) not list in the report, please check it in the DTS Website.</p> <p><input type="checkbox"/> <b>Pass with Deviation</b></p> <p>Comment: _____</p>
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Issue date

2014-10-22

Approval

Tom Lin

Test Engineer

Ben Sun

# Test Item List

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## Testing Result

Num	Test item list	Result	Remark
1	Temp./humidity power on/off test	Pass	
2	Room temperature test	Pass	
3	Temperature rise test	Pass	
4	High temperature storage test	Pass	
5	High temperature operation test	Pass	
6	Low temperature storage test	Pass	
7	Low temperature operation test	Pass	
8	Humidity test	Pass	
9	Temperature shock operation test	Pass	
10	Temperature shock non-operation test	Pass	
11	Cold start and hot start test	Pass	

# Configuration of EUT

<b>Test Product: RTC-700C</b>		
<b>Sample Configuration &amp; Quantity Under Test:</b>		
<b>Num</b>	<b>Item</b>	<b>Spec</b>
RTC-700C		
01.	<b>CPU:</b>	Intel® Atom™ Z2760 Processor / 1.8GHz
02.	<b>PCBA</b>	RTC-700C A0.3
03.	<b>BIOS</b>	BIOS (V0.4.7)
04.	<b>Memory</b>	DDRII 2GB Mobile RAM
05.	<b>mSATA</b>	eMMC 64GB/ SanDisk.SDIN7DP4-64G
	<b>3G</b>	Anydata DTL718-W-P
06.	<b>WLAN + BT Module</b>	AW-AH691
07.	<b>Battery</b>	JHT.JHT-795RTC70-A(J1067-1), 2S1P 3700mAh
08.	<b>AC Adapter</b>	LTE24E-S2-2C6 (Output: 12V / 2A)
09.	<b>Test Software</b>	Windows Embedded 8.1 / Run PassMark BurnIn Test 7.0 Pro

# Temp./humidity power on/off test

**Test Date:** 10-08~09 - 2014

**Test Model:** RTC-700C Main Board only

**Test Site:** AAEON QE Dept.

**Test Standard:** Refer to IEC 68-2-30 Testing procedures  
 Test Db: Damp Heat Test  
 Refer to IEC 68-2-1 Testing procedures  
 Test Ab: Cold Test

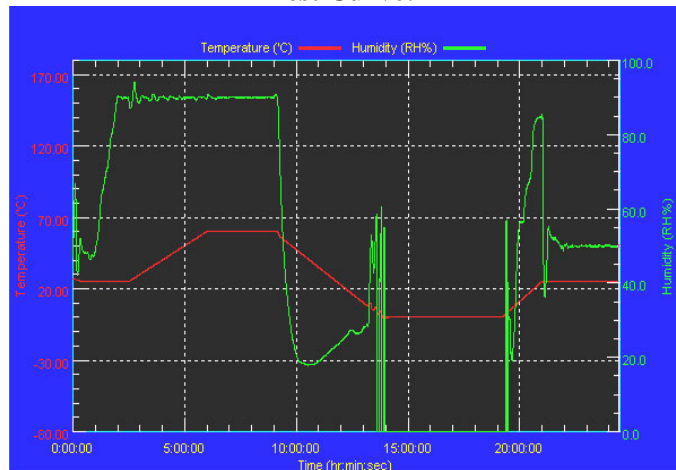
**Test Equipment:**  
 Programmable Temperature & Humidity Chamber  
 K.SON. INS. TECH. CORP.  
 Model: THS-B6T-150+LN2  
 Date of Calibration: 09/1/14  
 Serial Number: 9095KT

## Temperature & Humidity Power On/Off Test:

### Testing Specification:

Step	Temperature (°C)	Humidity (%RH)	Duration (HH:MM)
1	25	50	00:30
2	25	50	00:30
3	25	90	01:00
4	25	90	00:30
5	60	90	03:30
6	60	90	03:00
7	0	0	04:50
8	0	0	05:23
9	25	50	01:47
10	25	50	03:00

### Test Curve:



## Test Result:

No issues were found during the temperature & humidity power on/off test.

Test Method	Actual	Successful	Failure rate
Power On/Off	1835/times	1835/times	0 %
Note: Failure rate need to be 0%.			

# Room Temperature test

**Test Date:** 10-13-2014

**Test Product:** RTC-700C

**Test Site:** AAEON QE Dept.

**Temperature Measurement:**

40 Channel Thermal Recorder:  
YOKOGAWA Inc,  
Model: DA100-13-1D  
Date of Calibration: 09/11/14  
Serial Number: 12A323190

**Test Condition:**

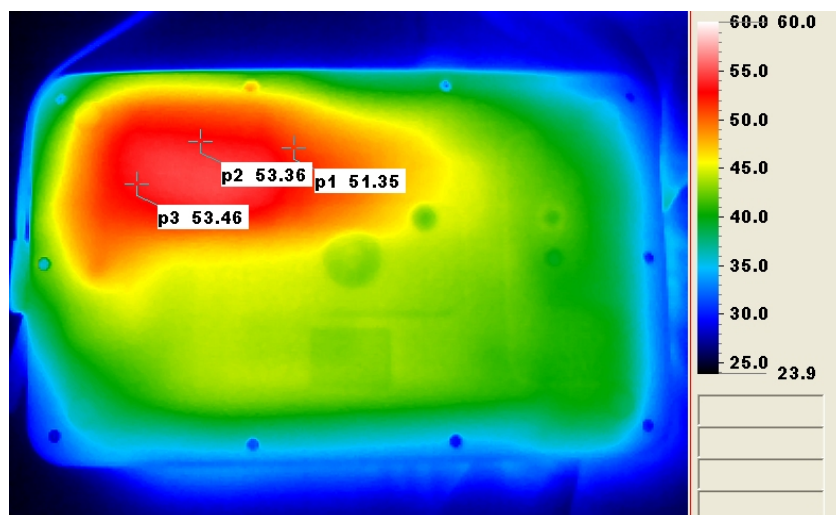
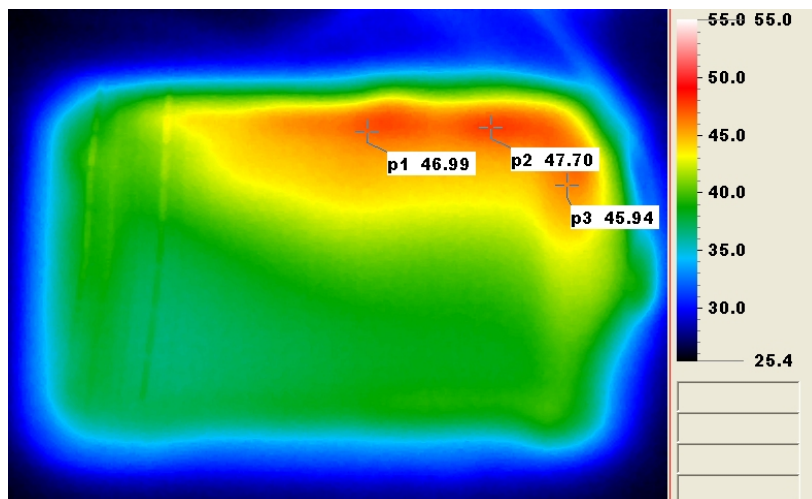
Ambient temperature: 25°C  
Continuous running till thermal stability (within less than 1°C)

**Test Software:**

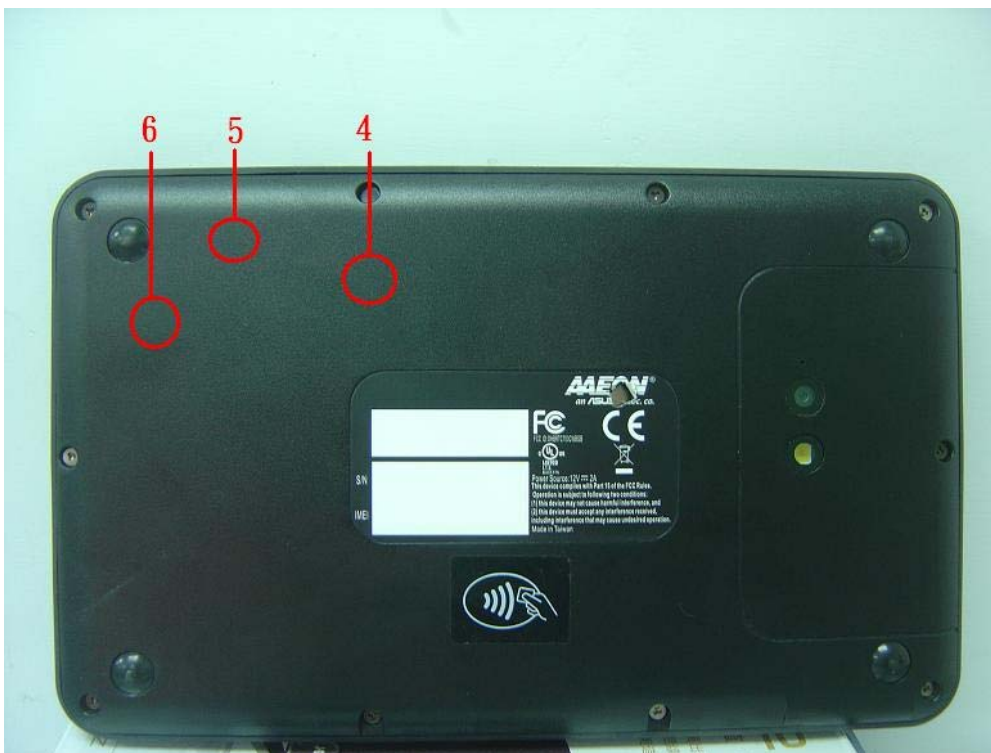
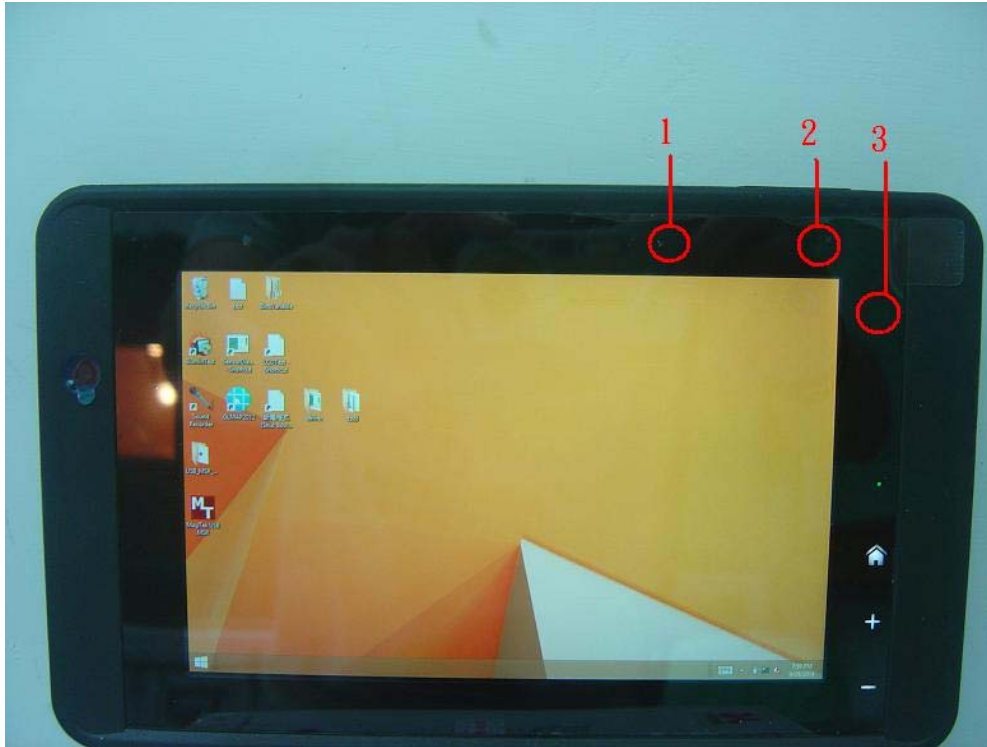
Windows Embedded 8.1 / Run PassMark Burn In Test 7.0 Pro

**Terminal Recorder:**

Measuring Thermal Couple Position :



# Room Temperature test



**Thermal profile data:****RTC-700C**

Point	Temp. Stage(°C)	Spec	25
1. Point 1		$\Delta T$ $\leq 25$ °C	40.2
2. Point 2			44.2
3. Point 3			40.7
4. Point 4			44.7
5. Point 5			41.6
6. Point 6 -			39.9
Room Temperature			25.1
<b>Any Tm value showed in red words which meaning the value over the Tc degree Cof this device specification.</b>			

**Sample Configuration & Quantity Under Test:**

Quantity: 1 (RTC-700C)

**Test Result:**

No issues were found during the room temperature operation test.

# Temperature rise test

**Test Date:** 10-14~15-2014

**Test Product:** RTC-700C

**Test Site:** AAEON QE Dept.

**Test Standard:** Refer to EN 61131-2(94), UL508 (94)

**Temperature Measurement:**

40 Channel Thermal Recorder:

YOKOGAWA Inc,

Model: DA100-13-1D

Date of Calibration: 09/11/14

Serial Number: 12A323190

**Test Condition:**

Ambient temperature: 27°C

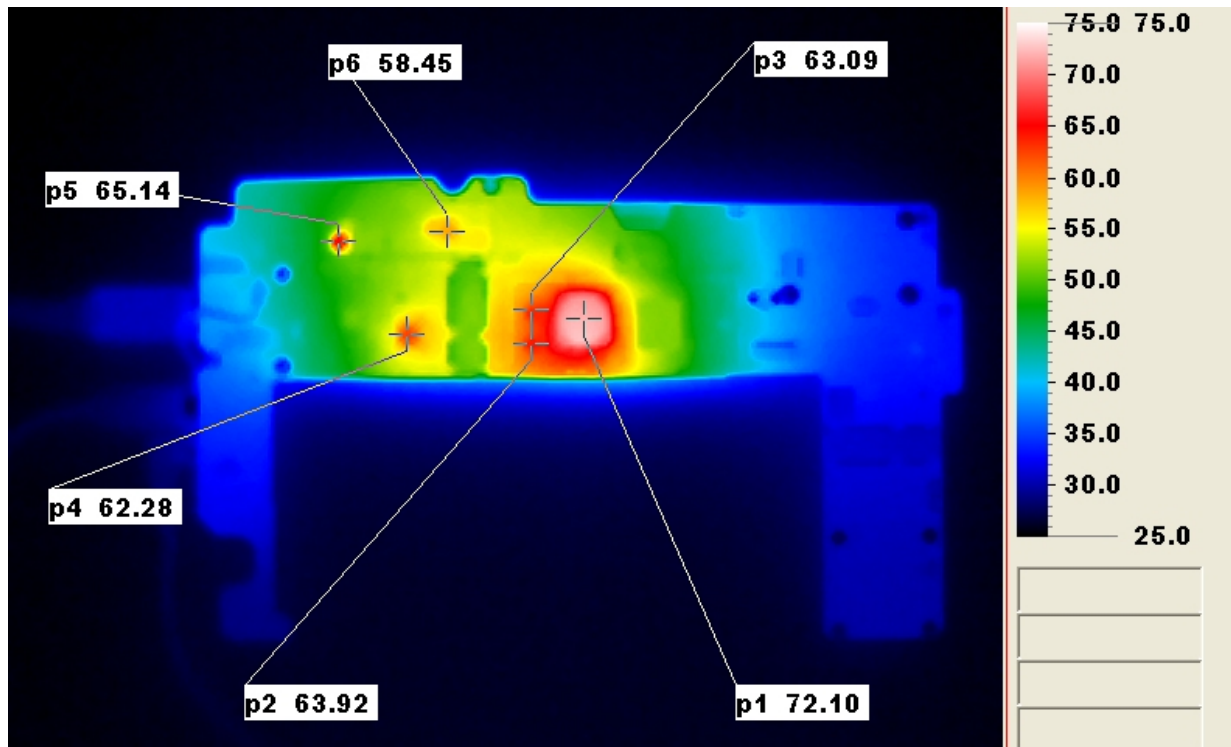
Continuous running till thermal stability (within less than 1°C)

**Test Software:**

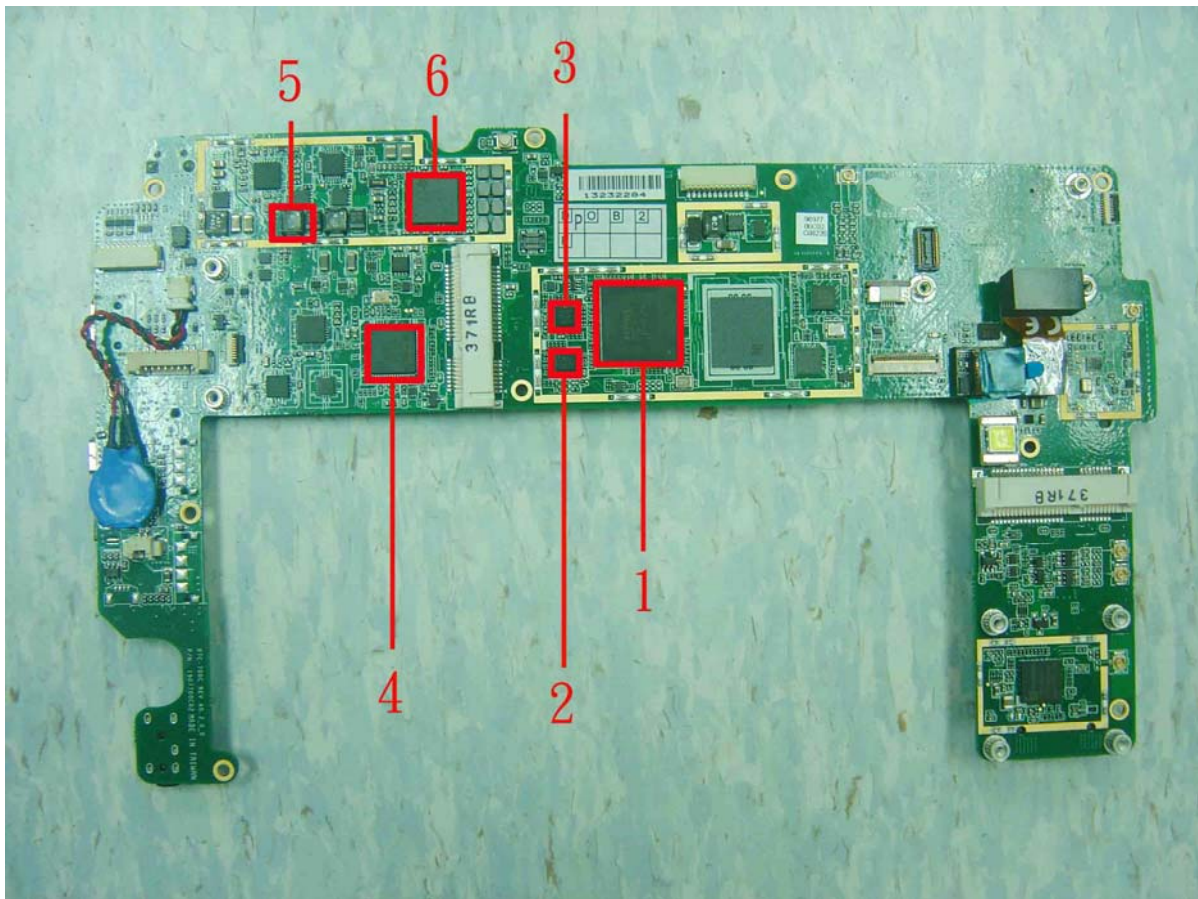
Windows Embedded 8.1 / Run PassMark Burn In Test 7.0 Pro

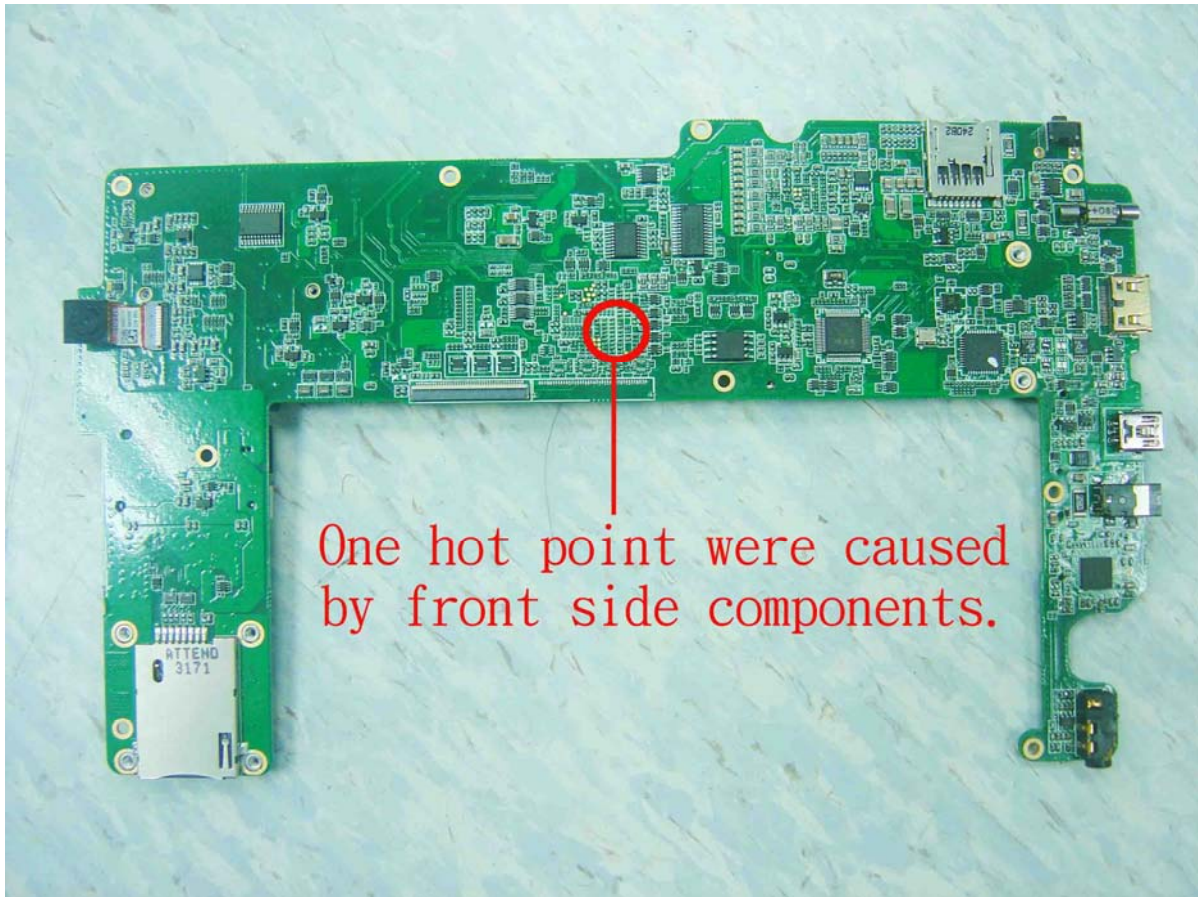
**Terminal Recorder:**

Measuring Thermal Couple Position :









**Thermal profile data:**

**RTC-700C**

Point	Position	Describe	Tc (*1) (°C)	Tm (*2) Measured Under	Note
				27.0°C	
1	Bottom - U1	(TF)INTEL SOC.Cloverview.1.8GHz. Atom Z2760	90°C	69.8	
	Top - U4	(TF)DDR2 Mobile RAM PoP. ELPIDA.EDBA164B1PF-1D-F	85°C		
2	U5	(TF)ULPI Hi-Speed.USB Transceiver. TI.TUSB1211A1ZRQR	100°C	61.5	
3	U6	(TF)ULPI Hi-Speed.USB Transceiver. TI.TUSB1211A1ZRQR	100°C	64.5	
4	U75	(TF)USB2.0 7-PORT HUB CONTROLLER..SMSC.USB2517i-JZX	85°C	70.7	
5	U72	(TF) Integrated Power Management. TI.SNB5072A1ZNBR	85°C	67.4	
6	L15	(TF)COIL. COOPER.MPI4040R3-3R3-R	125°C	65.6	

**Note(\*):**

1. "Tc" indicates the component's case maximum temperature value specified in its datasheet.
2. "Tm" indicates the measured Tc value under working environmental temperature within product specification.

**Sample Configuration & Quantity Under Test:**

Quantity: 1 (RTC-700C)

**Test Result:**

No issues were found during the temperature rise operation test.

# High temperature storage test

**Test Date:** 09-15 ~ 22-2014

**Test Product:** RTC-700C

**Test Site:** AAEON QE Dept.

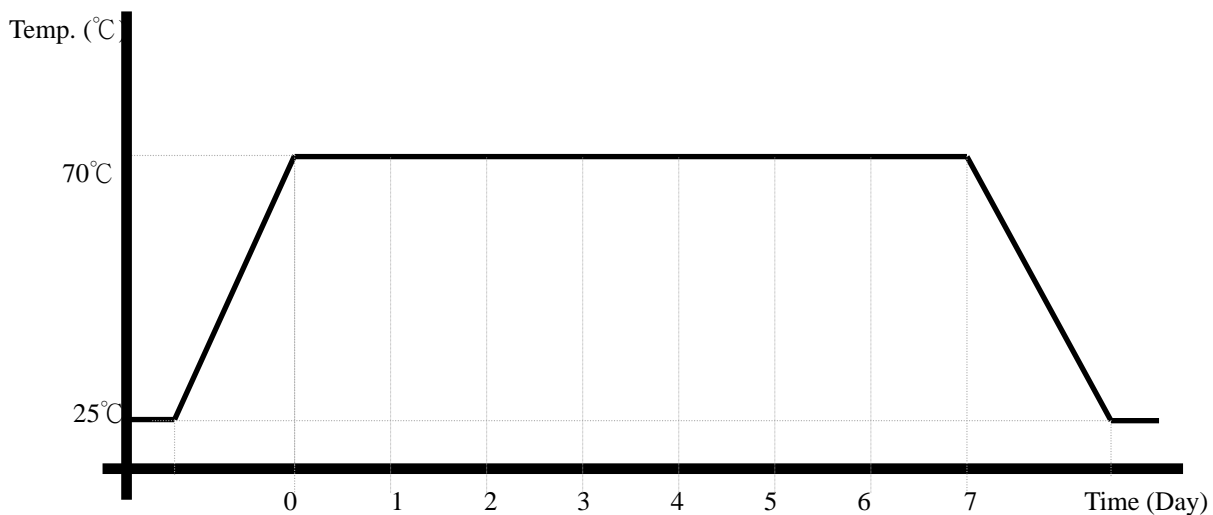
**Test Standard:** Refer to MIL-STD 810G Method 501.5 High Temperature  
Procedure I - Storage

**Test Equipment:**

Programmable Temperature & Humidity Chamber (K.SON. INS. TECH. CORP.)  
Model: THS-B6T-150+LN2  
Date of Calibration: 09/01/14  
Serial Number: 9095KT

**Testing Item:**

1. Test Temperature: 70°C
2. Test Time: 7days
3. Test Environment Curve:



**Sample Configuration & Quantity Under Test:**

Quantity: 1 (RTC-700C)

**Test Result:**

No issues were found after the high temperature storage test.

# High temperature operation test

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**Test Date:** 09-09 ~ 13-2014

**Test Product:** RTC-700C

**Test Site:** AAEON QE Dept.

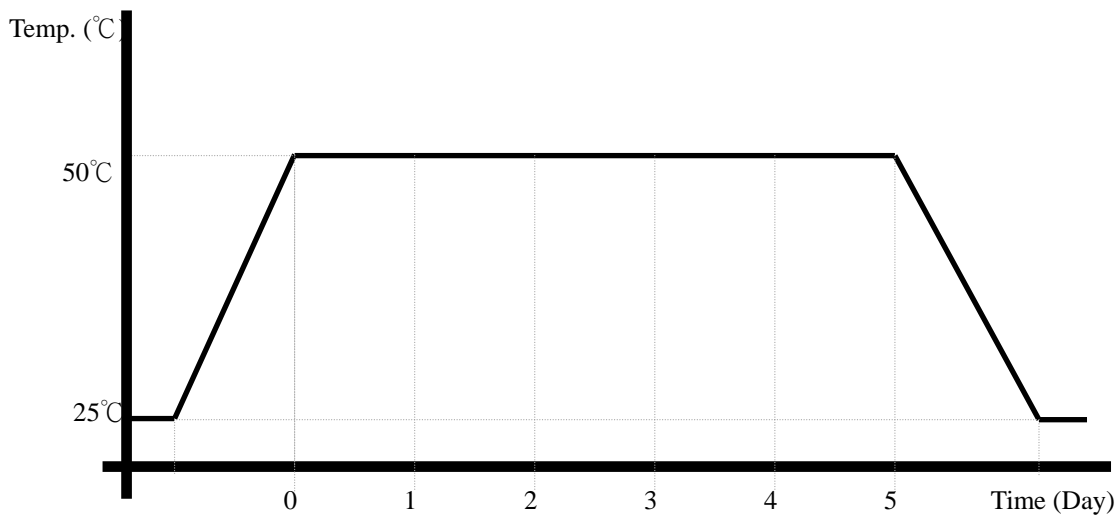
**Test Standard:** Refer to MIL-STD 810G Method 501.5 High Temperature  
Procedure II - Operation

**Test Equipment:**

Programmable Temperature & Humidity Chamber (K.SON. INS. TECH. CORP.)  
Model: THS-B6T-150+LN2  
Date of Calibration: 09/01/14  
Serial Number: 9095KT

**Testing Item:**

4. Test Temperature: 55°C
5. Test Time: 5days
6. Test Software: Windows Embedded 8.1 / Run PassMark Burn In Test 7.0 Pro
7. Test Environment Curve:



**Sample Configuration & Quantity Under Test:**

Quantity: 1 (RTC-700C)

**Test Result:**

No issues were found during the high temperature operation test.

# Low temperature storage test

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**Test Date:** 09-05~06-2014

**Test Product:** RTC-700C

**Test Site:** AAEON QE Dept.

**Test Standard:** Refer to MIL-STD 810G Method 502.5 Low Temperature  
Procedure I - Storage

**Test Equipment:**

Programmable Temperature & Humidity Chamber (K.SON. INS. TECH. CORP.)

Model: THS-B6T-150+LN2

Date of Calibration: 09/01/14

Serial Number: 9095KT

**Testing Item:**

1. Test Temperature: -55°C
2. Test Times: 24Hrs
3. Test Environment Curve:



**Sample Configuration & Quantity Under Test:**

Quantity: 1 (RTC-700C)

**Test Result:**

No issues were found after the low temperature storage test.

# Low temperature operation test

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**Test Date:** 09-01~02-2014

**Test Product:** RTC-700C

**Test Site:** AAEON QE Dept.

**Test Standard:** Refer to MIL-STD 810G Method 502.5 High Temperature  
Procedure II - Operation

**Test Equipment:**

Programmable Temperature & Humidity Chamber (K.SON. INS. TECH. CORP.)

Model: THS-B6T-150+LN2

Date of Calibration: 09/01/14

Serial Number: 9095KT

**Testing Item:**

1. Test Temperature: -23°C
2. Test Times: 24Hrs
3. Test Software: Windows Embedded 8.1 / Run PassMark Burn In Test 7.0 Pro
4. Test Environment Curve:



**Sample Configuration & Quantity Under Test:**

Quantity: 1 (RTC-700C)

**Test Result:**

No issues were found during the low temperature operation test.

# Humidity test

**Test Date:** 09-23~27-2014

**Test Product:** RTC-700C

**Test Site:** AAEON QE Dept.

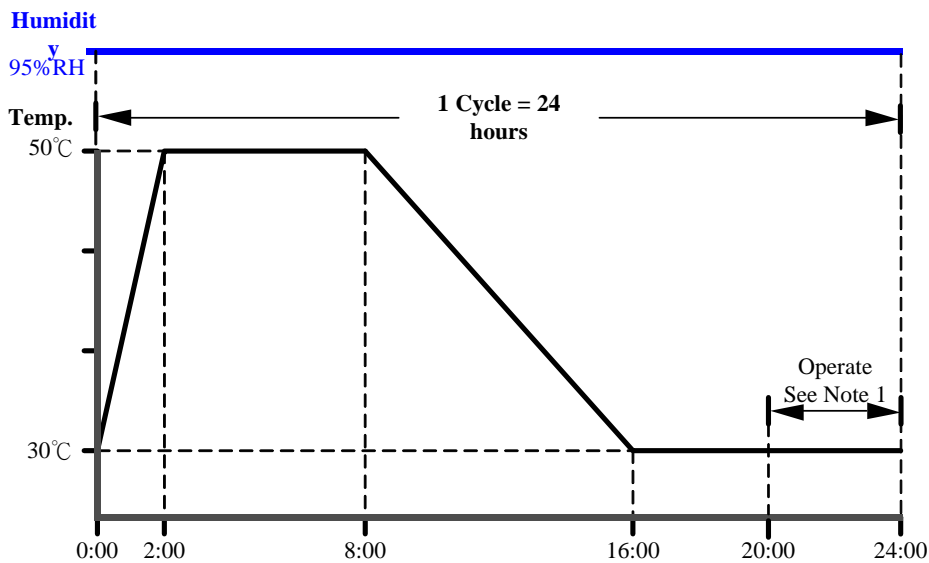
**Test Standard:** Refer to MIL-STD 810G Method 507.5 Testing  
Procedures II – Aggravated Cycle (FIGURE 507.5-7)

**Test Equipment:**

Programmable Temperature & Humidity Chamber (K.SON. INS. TECH. CORP.)  
Model: THS-B6T-150+LN2  
Date of Calibration: 09/01/14  
Serial Number: 9095KT

**Test Condition:**

1. Test Humidity: 95%RH
2. Test Temperature: 50°C / 30°C
3. Test Times: 24Hrs / Cycle
4. Test Cycle: 5 Cycles
5. Test Environment Curve:



NOTES:

1. Perform operational checks near the end of the fifth cycles.

**Sample Configuration & Quantity Under Test:**

Quantity: 1 (RTC-700C)

**Test Result:**

No issues were found after the humidity storage test.

# Temperature shock operation test

**Test Date:** 09-29~30-2014

**Test Product:** RTC-700C

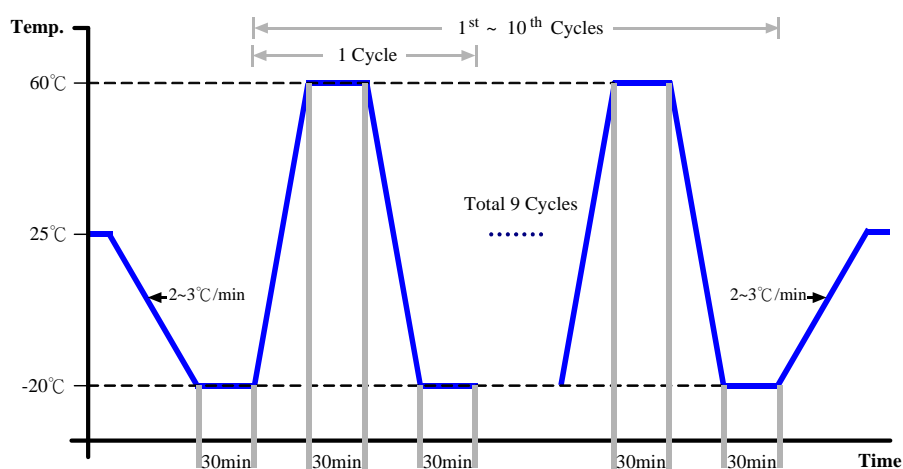
**Test Site:** AAEON QE Dept.

**Test Standard:** Refer to MIL-STD 810G Method 503.5 Temperature Shock  
Procedure I - Shock from constant extreme temperatures

**Test Equipment:**  
Programmable Temperature & Humidity Chamber (K.SON. INS. TECH. CORP.)  
Model: THS-B6T-150+LN2  
Date of Calibration: 09/01/14  
Serial Number: 9095KT

## Test Condition:

1. Test Low Temperature:  $-20^{\circ}\text{C}$
2. Test High Temperature:  $60^{\circ}\text{C}$
3. Test dwell time: 30min
4. Temperature slope: 5 min
5. Test cycle: 10 cycles
6. Test Software: Windows Embedded 8.1 / Run PassMark Burn In Test 7.0 Pro
7. Test Environment Curve:



## Sample Configuration & Quantity Under Test:

Quantity: 1 (RTC-700C)

## Test Result:

No issues were found during the variation temperature operation test.



# Temperature shock non-operation test

**Test Date:** 10-01~03-2014

**Test Product:** RTC-700C

**Test Site:** AAEON QE Dept.

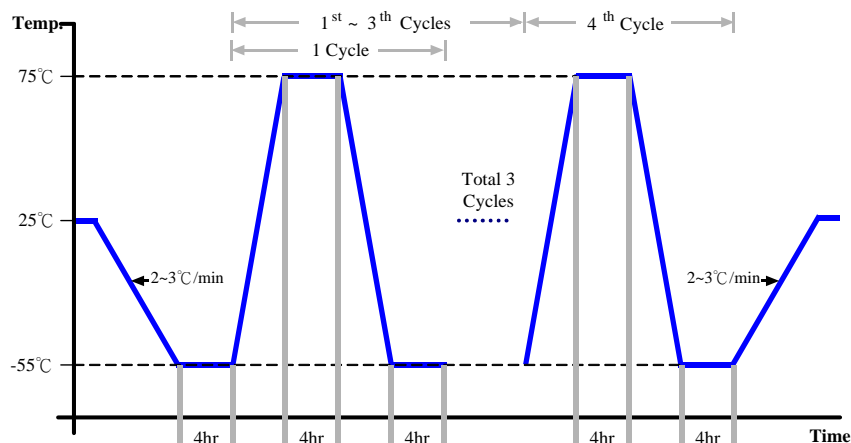
**Test Standard:** Refer to MIL-STD 810G Method 503.5 Temperature Shock  
Procedure I - Shock from constant extreme temperatures

**Test Equipment:**

Programmable Temperature & Humidity Chamber (K.SON. INS. TECH. CORP.)  
Model: THS-B6T-150+LN2  
Date of Calibration: 09/01/14  
Serial Number: 9095KT

**Test Condition:**

1. Test Low Temperature: -55°C
2. Test High Temperature: 75°C
3. Test dwell time: 4Hrs
4. Temperature slope: 10 min
5. Test cycle: 4 cycles
6. Test Environment Curve:



**Sample Configuration & Quantity Under Test:**

Quantity: 1 (RTC-700C)

**Test Result:**

No issues were found after the variation temperature non-operation test.

# Cold start and hot start test

**Test Date:** 10-06~07-2014

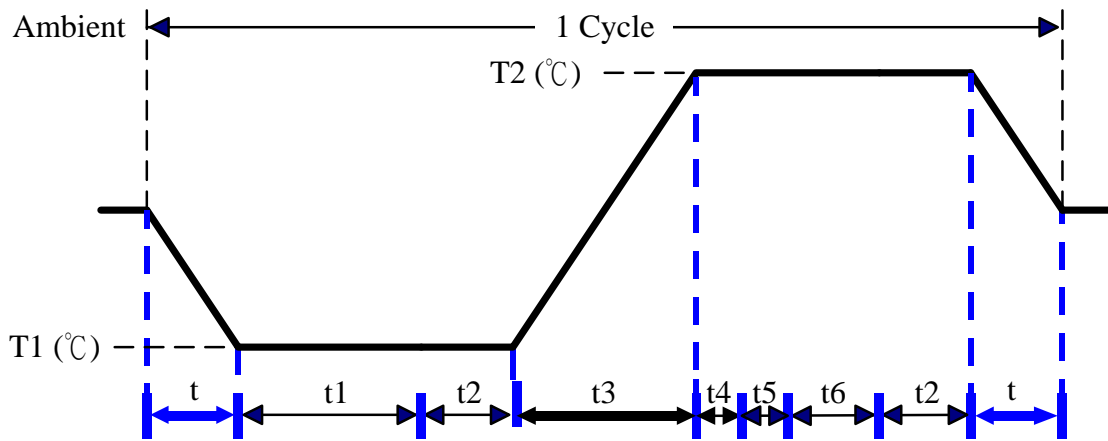
**Test Product:** RTC-700C

**Test Site:** AAEON QE Dept.

**Test Standard:** Refer to IEC 68-2-14 Testing procedures  
Test N: Change of temperature Test

**Test Equipment:**  
Programmable Temperature & Humidity Chamber (K.SON. INS. TECH. CORP).  
Model: THS-B6T-150+LN2  
Date of Calibration: 09/01/14  
Serial Number: 9095KT

**Test Condition:**



Parameters	Description
T1	-5°C
T2	45°C
t1	4 hrs
t2, t6	2 hrs
t4, t5	1hrs
t, t3	2°C/min
n (Cycle)	1

t = temprature slope  
t, t1, t6: Power Off  
t2: Power on/off test 10 times (on 2 min / off 5min)  
t3, t4: Run PassMark Burn In Test  
t5: Win XP Software restart test 3 times  
Test Software: Windows 8.1

**Test Result:**

- a. No issues were found during the cold start test.
- b. No issues were found during the hot start test.